

# < L/S band internally matched power GaAs FET >

# **MGFS45V2527A**

2.5 - 2.7 GHz BAND / 32W

### **DESCRIPTION**

The MGFS45V2527A is an internally impedance-matched GaAs power FET especially designed for use in 2.5 - 2.7 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

### **FEATURES**

Class A operation

Internally matched to 50(ohm) system

- High output power
  - P1dB=32W (TYP.) @f=2.5 2.7GHz
- High power gain
  - ĞLP=12.0dB (TYP.) @f=2.5 2.7GHz
- High power added efficiency
  - P.A.E.=45% (TYP.) @f=2.5 2.7GHz
- Low distortion [item -51]
  - IM3=-45dBc (TYP.) @Po=34.5dBm S.C.L

## **APPLICATION**

- item 01: 2.5 2.7 GHz band power amplifier
- item 51: 2.5 2.7 GHz band digital radio communication

### **QUALITY**

• IG

### **RECOMMENDED BIAS CONDITIONS**

• VDS=10V • ID=6.5A • RG=25ohm

# Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain breakdown voltage	-15	V
VGSO	Gate to source breakdown voltage	-15	V
ID	Drain current	22	Α
IGR	Reverse gate current	-61	mA
IGF	Forward gate current	76	mA
PT *1	Total power dissipation	88	W
Tch	Cannel temperature	175	°C
Tstg	Storage temperature	-65 to +175	°C

\*1 : Tc=25°C

# OUTLINE DRAWING 24.0±0.3(0.945±0.012) 0.6±0.15 (0.024±0.006) 15.8(0.622)

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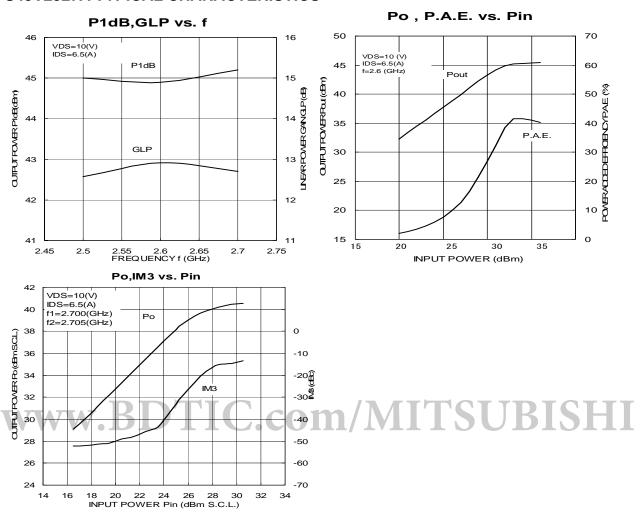
# Electrical characteristics (Ta=25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Тур.	Max.	
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=60mA	-	-	-5	V
P1dB	Output power at 1dB gain compression	VDS=10V,ID(RF off)=6.5A	44	45	-	dBm
GLP	Linear Power Gain	f=2.5 - 2.7GHz	11	12	-	dB
ID	Drain current		-	7.5	-	Α
P.A.E.	Power added efficiency		-	45	-	%
IM3 *2	3rd order IM distortion		-42	-45	-	dBc
Rth(ch-c) *3	Thermal resistance	delta Vf method	-	-	1.5	°C/W

<sup>\*2 :</sup>item -51 ,2 tone test,Po=34.5dBm Single Carrier Level ,f=2.5,2.6,2.7GHz,delta f=5MHz

<sup>\*3 :</sup>Channel-case

## MGFS45V2527A TYPICAL CHARACTERISTICS



MGFS45V2527A S-parameters ( Ta=25deg.C , VDS=10(V),IDS=6.5(A) )

	S-Parameter (TYP.)								
f	S11		S21		S12		S22		
(GHz)	Magn.	Angle(deg)	Magn.	Angle(deg)	Magn.	Angle(deg)	Magn.	Angle(deg)	
2.40	0.34	-172	4.68	75	0.03	40	0.26	-48	
2.42	0.35	-176	4.65	70	0.03	34	0.26	-53	
2.44	0.37	177	4.63	64	0.03	26	0.24	-57	
2.46	0.40	170	4.60	58	0.03	19	0.24	-65	
2.48	0.41	163	4.56	52	0.03	14	0.22	-69	
2.50	0.43	157	4.53	46	0.03	5	0.21	-79	
2.52	0.43	151	4.51	40	0.03	-1	0.20	-81	
2.54	0.44	145	4.49	34	0.04	-9	0.20	-86	
2.56	0.45	139	4.47	28	0.03	-15	0.20	-91	
2.58	0.45	134	4.44	22	0.04	-22	0.20	-97	
2.60	0.45	128	4.43	16	0.04	-29	0.19	-104	
2.62	0.45	122	4.42	10	0.04	-37	0.19	-108	
2.64	0.44	116	4.41	4	0.04	-42	0.19	-113	
2.66	0.44	110	4.40	-2	0.04	-50	0.19	-117	
2.68	0.43	103	4.40	-8	0.04	-55	0.19	-120	
2.70	0.42	96	4.39	-14	0.04	-62	0.18	-126	
2.72	0.40	88	4.37	-21	0.04	-70	0.18	-128	
2.74	0.39	80	4.37	-27	0.04	-74	0.17	-133	
2.76	0.37	71	4.35	-34	0.04	-79	0.17	-136	
2.78	0.36	61	4.34	-40	0.04	-88	0.16	-138	
2.80	0.34	50	4.32	-47	0.04	-95	0.16	-141	

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